

# DuPont 6119R

Ag/Pd Conductor Composition

EUROPEAN TECHNICAL DATASHEET

All values reported here are results of experiments in our laboratories intended to illustrate product performance potential with a given experimental design. They are not intended to represent the product's specifications, details of which are available upon demand

## Product Description

DuPont 6119R Ag/Pd conductor is intended to be applied to ceramic substrates by screen printing and fired in a conveyor furnace in an air (oxidising) atmosphere. It is a solderable conductor whose features make it an excellent choice in a wide variety of hybrid circuits.

## Product Benefits :

- Good solderability on 96% alumina substrates
- Optimised for 60 minute 850°C firing profile
- Phthalate, Cadmium free\*

\* Phthalate and Cadmium 'free' as used herein means that cadmium and phthalate are not intentional ingredients in and are not intentionally added to the referenced product. Trace amounts however may be present

## Processing Summary

- **Screen Type**  
200 mesh stainless steel screen with a 12-14 µm emulsion build up. 200 - 315 mesh stainless steel screen can be used.
- **Drying**  
Allow prints to level for over 5-10 minutes at room temperature, then dry for ≥ 10 -15 minutes at 150°C
- **Firing**  
850°C peak held for 10 minutes on 60 minute cycle in an air atmosphere (see Chart 1)

## Compatibility

Whilst DuPont has tested this composition with the materials specified above and the recommended processing conditions, it is impossible or impractical to cover every combination of materials, customer processing conditions and circuit layouts. It is therefore essential that customers thoroughly evaluate the material in their specific situations in order to completely satisfy themselves with the overall quality and suitability of the composition for its intended application (s).

## Storage and Shelf Life

Containers may be stored in a clean, stable environment at room temperature (between 5°C – 30°C) with their lids tightly sealed. Storage in high temperature (<30°C) or in freezers (temperature <0°C) is NOT recommended as this could cause irreversible changes in the material. For optimum viscosity performance, it is recommended that the product is processed shortly after receipt. The shelf life of compositions in factory-sealed (unopened) containers between (5°C – 30°C) is 6 months from date of shipment.

TABLE 1. TYPICAL PHYSICAL PROPERTIES

<b>Viscosity (Pa.s.)</b>	240 – 315
Brookfield HBT, utility cup and spindle, (SC4-14/6R), 10 rpm, 25°C±0.2°C	
<b>Coverage [cm<sup>2</sup>/g]</b>	50-60
Based on wet film thickness of 60µm	
<b>Shrinkage [%]</b>	
Wet to Dry	29
Dried to fired	50
<b>Thinner</b>	8250
<b>Shelf Life (months)</b>	6

## Substrates

Substrates of different compositions and from various manufacturers may result in variations in performance properties

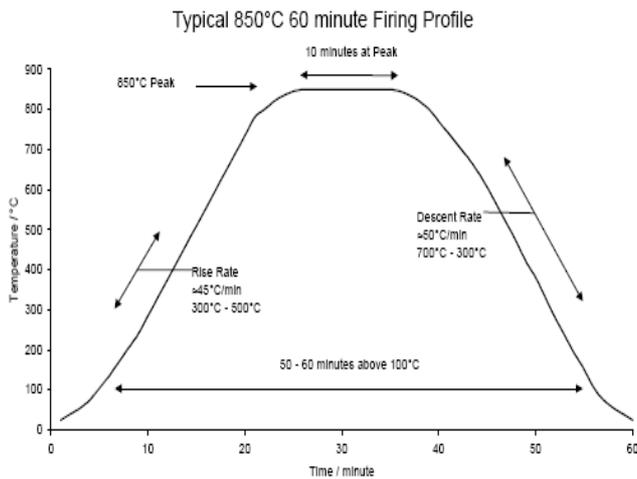
## Thinner

6119R composition is optimized for screen printing and thinning is not normally required. Use the DuPont recommended thinner for slight adjustments to viscosity or to replace evaporation losses. The



The miracles of science™

## CHART 1. FIRING PROFILE



use of too much thinner or the use of a non recommended thinner may affect the rheological behaviour of the material and its printing characteristics. Please refer to table 1. Typical Physical Properties'

### Printing

The composition should be thoroughly mixed before use. This is best achieved by slow, gentle hand stirring with a clean burr-free spatula (flexible plastic or stainless steel) for about 1-2 minutes. Care must be taken to avoid air entrapment. Printing should be performed in a well ventilated area. Additional information on requirements for printing areas is contained in DuPont Technical Guide EUT 7.3 'Processing-Screen Printing Rooms' available on request.

Note: optimum printing characteristics are generally achieved in the room temperature range of 20°C-23°C. It is therefore important that the material, in its container, is at the temperature prior to commencement of printing. Class 10,000 printing area is recommended for building complex hybrids and multilayer circuits, otherwise severe yield losses could occur. Refer to 'Processing Summary'.

### Drying

Allow prints to level at room temperature, then dry in a well ventilated oven or conveyor dryer. Refer to 'Processing Summary'.

### Firing

Fire in well ventilated belt, conveyor furnace or static furnace. Air flows and extraction rates should be optimized to ensure that oxidizing conditions exist within the muffle and that no exhaust gases enter the room.

Full information on requirements for firing is contained in DuPont Technical Guide EUT 7.4 'Process Guide-Firing'. Refer to 'Processing Summary'.

### General

Performance will depend to a large degree on care exercised in screen printing. Scrupulous care should be taken to keep the composition, printing screens and other tools free of metal contamination. Dust, lint and other particulate matter may also contribute to poor yields.

### Safety and Handling

DuPont thick film compositions are intended for use in an industrial environment by trained personnel. All appropriate health/ safety regulations regarding storage, handling and processing of such materials should be complied with. For information on health / safety regulations please refer to the specific product MSDS and to the DuPont Safety Guide EUT 7.1 'Practical Safe Handling of Thick Film Compositions'

**TABLE 2. TYPICAL FIRED PROPERTIES<sup>1</sup>**

<b>Fired Thickness (μm)</b>	13—15
<b>Print Resolution (μm lines and spaces)</b>	150-200
<b>Resistivity on alumina [mΩ/□] (@ 15μm fired thickness)</b>	25-35
<b>Solder Acceptance<sup>2</sup></b>	
62Sn/36Pb/2Ag@220°C	≥ 95% coverage
<b>Solder Leach Resistance</b>	
62Sn/36Pb/2Ag @230°C	8-9 cycles
<b>Adhesion [N]<sup>3</sup></b>	
Initial	20-28
Aged 48hrs@ 150°C	20-26

**Test Procedure**

1 Typical properties are based on laboratory data using recommended processing procedures. Unless expressly noted elsewhere the following processing conditions have been used:

Printing: 200 mesh stainless steel screen, 12-14μm emulsion thickness

Firing: 3x 60 minute cycles to a peak temperature of 850°C for 10 minutes

Tested on 96% alumina substrates

2 Using Alpha 611 flux. Solder coverage measured after a 5s dip in solder. A leaching cycle is represented by a 10s dip in solder and tested on 500μm lines. See soldering test procedure for details (H-1.12)

3 90° wire peel test on 2mmx 2mm pads soldered with 62Sn/36Pb/2Ag solder at 220°C and using a mildly activated Alpha 611. See wire peel adhesion test procedure for details (E-3.12)

The information provided herein corresponds to our knowledge on the subject at the date of its publication. This information may be subject to revision as new knowledge and experience becomes available. The data provided fall within the normal range of product properties and relate only to the specific material designated; these data may not be valid for such material used in combination with any other materials or additives or in any process, unless expressly indicated otherwise. The data provided should not be used to establish specification limits or used alone as the basis of design; they are not intended to substitute for any testing you may need to conduct to determine for yourself the suitability of a specific material for your particular purposes. Since DuPont cannot anticipate all variations in actual end-use conditions DuPont makes no warranties and assumes no liability in connection with any use of this information. Nothing in this publication is to be considered as a license to operate under or a recommendation to infringe any patent rights.

Do not use DuPont materials in

medical applications involving implantation in the human body or contact with internal body fluids or tissues unless the material has been provided from DuPont under a written contract that is consistent with the DuPont policy regarding medical applications and expressly acknowledges the contemplated use.

DUPONT MAKES NO REPRESENTATION, PROMISE, EXPRESS WARRANTY OR IMPLIED WARRANTY CONCERNING THE SUITABILITY OF THESE MATERIALS FOR USE IN IMPLANTATION IN THE HUMAN BODY OR IN CONTACT WITH INTERNAL BODY FLUIDS OR TISSUES.

Copyright © 2013 DuPont. All rights reserved. The DuPont Oval Logo, DuPont™, The miracles of science™ and all products denoted with ® or ™ are registered trademarks or trademarks of E. I. du Pont de Nemours and Company or its affiliates.

K26764 3/2013

For more information on DuPont 6119R or other DuPont Microcircuit Materials products, please contact your local representative:

### Americas

#### DuPont Microcircuit Materials

14 T.W. Alexander Drive  
Research Triangle Park  
NC 27709  
Tel.: 1 919 248 5188

### Europe

Du Pont (U.K.) Limited  
Bristol Business Park  
Coldharbour Lane, Frenchay  
Bristol, BS16 1QD  
U.K.  
Tel.: 44 117 931 3191

### Asia

#### Japan

#### DuPont Kabushiki Kaisha

MCM Technical Lab  
DuPont Electronics Center  
KSP R&D B213  
2-1, Sakado 3-chom, Takatsu-ku,  
Kawasaki-shi, Kanagawa, 213-0012  
Japan  
Tel +81 44 820 7575

#### DuPont Taiwan Ltd.

45, Hsin-pong Rd,  
Taoyuan,  
Taiwan, 330  
Tel : 886 3 377 3660

#### DuPont China Holding Co. Ltd

Bldg 11, 399 Keyuan Rd., Zhangji Hi-Tech Park,  
Pudong New District, Shanghai 201203, China  
Tel: 86 21 6386 6366 ext.2202

#### DuPont Korea Inc.

3~5th Floor, Asia Tower #726,  
Yeoksam-dong, Gangnam-gu,  
Seoul 135-719, Korea  
Tel: 82 10 6385 5399

#### E.I. DuPont India Private Limited

7th Floor, Tower C, DLF Cyber Greens, Sector-25A,  
DLF City, Phase-III, Gurgaon 122 002, Haryana,  
India  
Tel: 91 124 4091818

#### DuPont Company (Singapore) Pte Ltd

1 HarbourFront Place, #11-01  
HarbourFront Tower One  
Singapore 098633  
Tel: 65 6586 3022

[mcm.dupont.com](http://mcm.dupont.com)



The miracles of science™